

ATP Industrial Grade Wide-Temperature Z-U130 eUSB SSD Specification

Revision 2.5



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Revision History

| Date | Version | Changes compared to previous issue |
|-------------------------------|----------------|---|
| June 25 th , 2008 | 1.0 | - Base version |
| Dec. 9 th , 2008 | 1.1 | - Add 2.00mm pitch low profile products |
| Feb. 18 th , 2009 | 1.2 | - Change product image and mechanicals |
| Sept. 21 st , 2009 | 1.3 | - Modify pin numbering orientation in Pin Assignment |
| Dec. 24 th , 2009 | 1.4 | - Update the Low Profile Mechanical and Dimension |
| Apr. 7 th , 2010 | 1.5 | - Add circle type mounting hole eUSB SSD product - Update the performance |
| July 28 th , 2010 | 1.6 | - Add 16GB SLC |
| Feb. 25 th , 2011 | 1.7 | - Added New External P/N |
| Aug. 29 th , 2011 | 2.0 | - Added Power Protector feature and New BOM's P/N table - Updated product photos and performance data - Removed 512MB & 1GB version from 2.00mm & 2.54mm eUSB standard product lines. |
| Sept. 13 th , 2011 | 2.1 | - Updated Physical Dimension Specification & Mechanical and Dimension drawings. |
| May 11 th , 2012 | 2.2 | - Updated product photo |
| Aug. 8 th , 2012 | 2.3 | - Added Static Data Refresh feature |
| Aug. 27 th , 2012 | 2.4 | - Added 512MB and 1GB SLC versions |
| Sept. 5 th , 2012 | 2.5 | - Removed Static Data Refresh feature |

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Introduction

The ATP Industrial Grade Z-U130 eUSB SSD is a solid state drive based on high performance NAND flash memory. This 10-pin embedded Disk-On-Module product utilizes the standard USB 2.0 interface which provides a true plug & play feature. This low power and compact size product is suitable for embedded storage applications. ATP Industrial Grade Z-U130 eUSB SSD offers an extended operating temperature range of -40°C to 85°C, provides outstanding performance and proven reliability for products operating outside the standard temperature range.

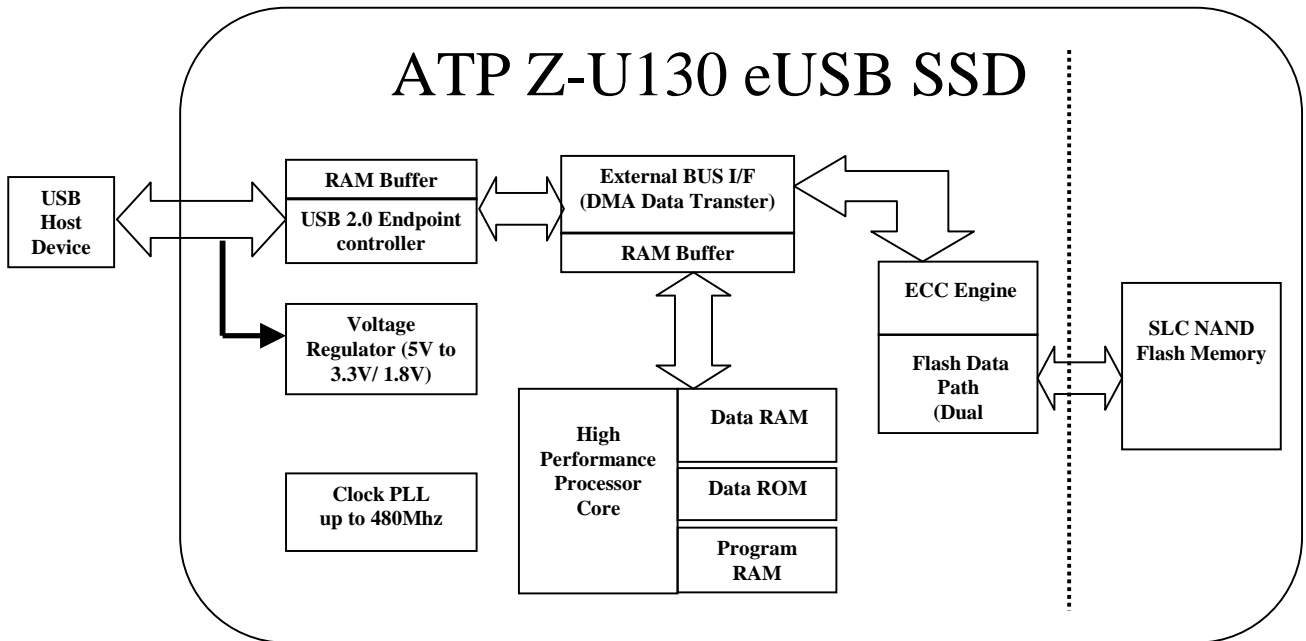
The ATP Industrial Grade Z-U130 eUSB SSD is designed for demanding industrial applications, such as military/aerospace, automotive, marine navigation, embedded, communication equipment or networking, medical equipment, and manufacturing, where mission-critical data requires the highest level of reliability, durability, and data integrity.

Main Features

- Complete USB specification ver.2.0 and ver. 1.1 compatibility,
- High Speed (480 Mbits/sec), Full Speed (12 Mbits/sec) and Low Speed (1.5 Mbits/sec) transfer support.
- Operating temperature: -40°C to 85°C
- True “Plug and play” connection, support hot swap
- Top level Single Level Cell (SLC) NAND flash memory
- Built in 8bit/512Byte ECC engine provides automatic error correction
- Advanced NAND management technology, static and dynamic wear-Leveling algorithm
- High reliability, MTBF(Mean Time Between Failures): 5,000,000 hours
- Enhanced bad block management algorithm
- Power Protector, built-in power-down data protection
- Shock & vibration resistance
- RoHS compliant
- CE, FCC certification

Block Diagram

ATP Industrial Grade Z-U130 eUSB SSD consists of below functional blocks. The advanced architecture is optimized to provide highest data reliability and transfer performance.



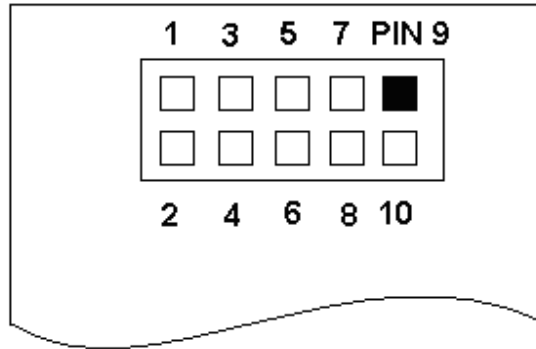
Product Images



Capacities

| ATP Industrial Grade Z-U130 eUSB SSD P/N | | | | CAPACITY |
|--|-----------------|-----------------------------------|-----------------|----------|
| Standard profile (2.54mm pin pitch) | External P/N | Low profile (2.00mm pin pitch) | External P/N | |
| AF512SSGH | AF512SSGH-AABXP | AF512SSGI | AF512SSGI-AABXP | 512MB |
| AF1GSSGH | AF1GSSGH-AABXP | AF1GSSGI | AF1GSSGI-AABXP | 1GB |
| AF2GSSGH | AF2GSSGH-AABXP | AF2GSSGI | AF2GSSGI-AABXP | 2GB |
| AF4GSSGH | AF4GSSGH-AABXP | AF4GSSGI | AF4GSSGI-AABXP | 4GB |
| AF8GSSGH | AF8GSSGH-AABXP | AF8GSSGI | AF8GSSGI-AABXP | 8GB |
| AF16GSSGH | AF16GSSGH-AAAXP | AF16GSSGI | AF16GSSGI-AAAXP | 16GB |

Pin Assignment



| PIN | SIGNAL | TYPE | PIN | SIGNAL | TYPE |
|-----|--------|-------|-----|--------|------|
| 1 | VCC | Power | 2 | NC | - |
| 3 | USBD- | I/O | 4 | NC | - |
| 5 | USBD+ | I/O | 6 | NC | - |
| 7 | GND | Power | 8 | NC | - |
| 9 | NC | - | 10 | NC | - |

Signal Description

| SIGNAL NAME | TYPE | DESCRIPTION |
|-------------|-------|-----------------------|
| VCC | Power | Bus Power Supply |
| USBD- | I/O | USB Data Negative Pin |
| USBD+ | I/O | USB Data Positive Pin |
| GND | Power | Ground |
| NC | - | No Connection |

Electrical Specifications

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
|-----------------|----------------------------------|------|------|------|------|
| V _{CC} | Recommend Supply Voltage | 4.5 | 5.0 | 5.5 | V |
| | Peak Voltage on any Pin | -0.3 | | 5.5 | V |
| I _{CC} | Operating Current (read & write) | | 100 | | mA |
| I _{SB} | Standby Current | | 50 | | mA |

Environment Specifications

| Parameter | | Value |
|-------------|---------------|--------------------------|
| Temperature | Operating | -40°C to 85°C |
| | Non-Operating | -40°C to 85°C |
| Humidity | Operating | 8% to 95%, noncondensing |
| | Non-Operating | 8% to 95%, noncondensing |
| Vibration | Operating | 15G peak-to-peak Max. |
| | Non-Operating | 15G peak-to-peak Max. |
| Shock | Operating | 2,000G Max. |
| | Non-Operating | 2,000G Max. |
| Altitude | Operating | 80,000 feet Max. |
| | Non-Operating | 80,000 feet Max. |

Reliability

- Data Retention: 10 years without power
- MTBF @ 25 °C: > 5,000,000 hours (Telcordia/Bellcore SR-332)
- Dynamic and Static wear leveling algorithm

Performance

| Parameter | Value |
|--------------------|----------------------------------|
| Data Transfer Rate | Sequential read up to 21MByte/s |
| | Sequential write up to 18MByte/s |

Certifications

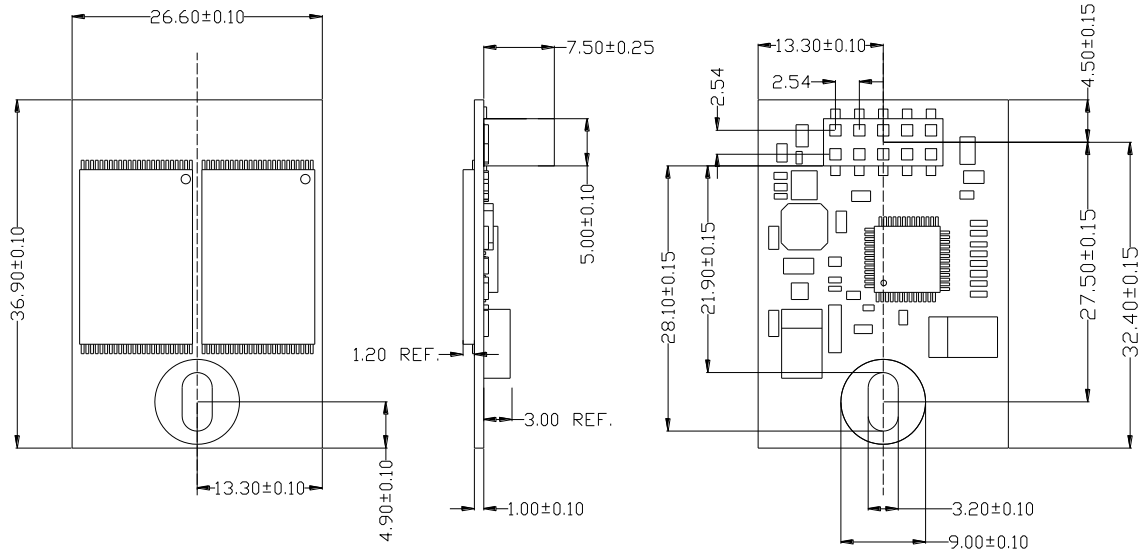
- RoHS compliant
- CE certification
- FCC certification

Physical Dimension Specifications

| Parameter | Value | |
|-----------|--|-----------------------------------|
| | Standard profile (2.54mm pin pitch) | Low profile (2.00mm pin pitch) |
| Length | 36.90+/- 0.10mm | 36.90+/- 0.10mm |
| Width | 26.60+/- 0.10mm | 26.60+/- 0.10mm |
| Thickness | 9.70+/- 0.25mm | 5.90+/- 0.25mm |

Mechanical Form Factor (Units in mm)

Standard Profile Mechanicals (2.54mm pin pitch connector):



Low Profile Mechanicals (2.00mm pin pitch connector):

